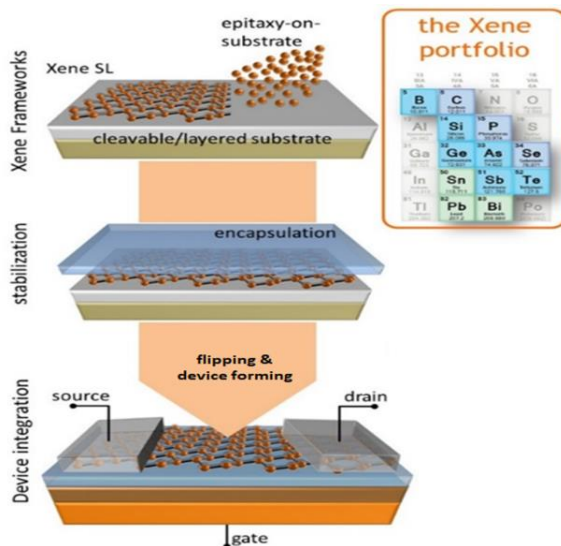


## Emerging 2D Xenos for Innovative Nanoelectronics

Two-dimensional (2D) Xenos (monoatomic sheets, e.g. silicene and phosphorene) have collective properties of mechanical flexibility and tunable bandgap holding great promise for novel nanoelectronics beyond graphene. Nonetheless, there is a challenge in experimental device studies largely due to air-stability related material and process issues. This talk highlights state-of-the-art experimental progress in synthesis, stabilization and device integration of monolayer silicene and thicker derivatives. With a unique sandwich encapsulation process, we enabled silicene transistor debut<sup>[1]</sup>. By tuning integration process and number of layers<sup>[2]</sup>, we further improved portability and reliability. Electrostatic characteristics of silicene field-effect transistor exhibits ambipolar charge transport with extracted mobility 100-200 cm<sup>2</sup>/V-s at residual carrier density  $\sim 8 \times 10^9$  cm<sup>-2</sup>, corroborating with theoretical predictions on Dirac cone in band structure. The electronic structure of silicene is expected to be sensitive to substrate interaction, surface chemistry, and spin-orbit coupling, holding great promise for a variety of novel applications, such as topological bits, quantum sensing and energy devices<sup>[3]</sup>. We applied above strategy to phosphorene, few-layer black phosphorus, and demonstrated mobility 310-1500 cm<sup>2</sup>/Vs, gate modulation  $10^{3-5}$  and intrinsic  $f_T=20$  GHz on flexible polyimide substrates<sup>[4,5]</sup>. Recent progress on silicene and phosphorene (transferable to other Xenos like stanine and germanene) represent a renewed opportunity for future nanoelectronics complementary to what is available in graphene<sup>[6]</sup>.



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Figure: Xene device integration.